



HIGH-POWER, WIDE VOLTAGE RANGE, QUAD-PORT ETHERNET POWER SOURCING EQUIPMENT MANAGER

FEATURES

- Quad-Port Power Management With Integrated Switches and Sense Resistors
- High Power PoE up to 25 W at PD Input Operating from a 53-V Minimum Input Power Rail
- Wide Range Single Supply: 21.5 V up to 57 V
- I_{CUT} = 615 mA, I_{LIM} = 650 mA Nominal
- IEEE 802.3af Compatible
- Individual Port 15-bit A/D Converters
- Auto, Semi-Auto and Power Management Modes
- Controlled Current Ramp Power-Up/Down for EMI Reduction
- Over-Temperature Protection
- DC Disconnect Detection, Supports AC Disconnect
- High-Speed 400-kHz I²C Interface
- Supports Legacy PD Detection
- PowerPAD™ Package
- Comprehensive Power Management Software Available for MPS430 Microcontroller

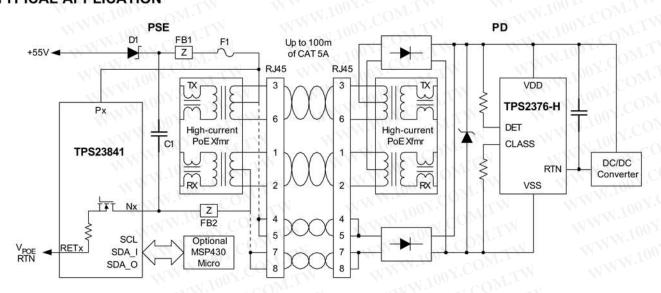
APPLICATIONS

- Medical/Industrial Applications at 24 V
- High Power Ethernet Enterprise Switches
- SOHO Hubs, Ethernet Hubs
- Ethernet High Power Mid-Spans
- High Power PSE Injectors

DESCRIPTION

The TPS23841 is a high-power, wide voltage range, quad-port sourcing equipment manager. TPS23841 can provide up to 570 mA per port over a wide temperature range (-40°C to +125°C). Each port may operate from 21.5 V up to 57 V. The integrated output eliminates two components per port (MOSFET and sense resistor) and survives 100-V transients. Four individual 15-bit A/D converters are used to measure signature resistance, voltage, current and die temperature, resulting in a simple and robust PSE solution. The TPS23841 comes with a comprehensive software solution to meet the most demanding applications which can serve as a core for all PoE system designs.

TYPICAL APPLICATION



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerPAD is a trademark of Texas Instruments.



DESCRIPTION (CONTINUED)

The TPS23841 has three internal supply buses (10 V, 6.3 V and 3.3 V) generated from the 48-V input supply. These supplies are used to bias all internal digital and analog circuitry. Each supply has been brought out separately for proper bypassing to insure high performance. The digital supply (3.3 V) is available for powering external loads up to 2 mA. For more demanding loads it is highly recommended to use external buffers to prevent system degradation. When the TPS23841 is initially powered up an internal Power-on-Reset (POR) circuit resets all registers and sets all ports to the off state to ensure that the device is powered up in a known safe operating state.

The TPS23841 has three modes of operation; auto mode (AM), semi-auto mode (SAM) and power management mode (PMM).

- In auto mode the TPS23841 performs discovery, classification and delivery of power autonomously to a compliant PD without the need of a micro-controller.
- In semi-auto mode the TPS23841 operates in auto mode but users can access the contents of all read status registers and A/D registers through the I²C serial interface. All write control registers are active except for D0 through D3 of port control register 1 (Address 0010) for limited port control. The semi-auto mode allows the TPS23841 to detect valid PD's without micro-controller intervention but adds a flexibility to perform power management activities.
- Power management mode (with a micro-controller) allows users additional capabilities of discovering non-compliant (legacy) PDs, performing AC Disconnect and advanced power management system control that are based on real time port voltages and currents. All functions in this mode are programmed and controlled through read/write registers over the I²C interface. This allows users complete freedom in detecting and powering devices. A comprehensive software package is available that mates the power of the TPS23841 with the MSP430 micro-controller.

TPS23841 integrated output stage provides port power and low-side control. The internal low-side circuitry is designed with internal current sensing so there are no external resistors required. The output design ensures the power switches operate in the fully enhanced mode for low power dissipation.

The I²C interface allows easy application of opto-coupler circuitry to maintain Ethernet port isolation when a ground based micro-controller is required. The TPS23841 five address pins (A1–A5) allow the device to be addressed at one of 31 possible I²C addresses. Per-port write registers separately control each port state (discovery, classification, legacy, power up, etc) while the read registers contain status information of the entire process along with parametric values of discovery, classification, and real-time port operating current, voltage and die temperature.

The proprietary 15-bit integrating A/D converter is designed to meet the harsh environment where the PSEPM resides. The converter is set for maximum rejection of power line noise allowing it to make accurate measurements of line currents during discovery, classification and power delivery for reliable power management decisions.

The TPS23841 is available in either 64-pin PowerPAD™ down (PAP) or 64-pin PowerPAD up (PJD) packages.

ORDERING INFORMATION

TEMPERATURE RANGE	PACKAGED	DEVICES ⁽¹⁾
T _A = T _J	TQFP – 64 (PAP) ⁽²⁾	TQFP - 64 (PJD) ⁽²⁾
-40°C to 125°C	TPS23841PAP	TPS23841PJD

- (1) The PAP and PJD packages are available taped and reeled. Add R suffix to device type (e.g.TPS23841PAPR) to order quantities of 1,000 devices per reel.
- (2) PAP = PowerPad down, PJD = PowerPad up.

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ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) (1)(2)

- 1	PARAMETER	VALUE	UNIT
\mathfrak{IM}_{r}	V10 current sourced	100	μΑ
Mo	V3.3 current sourced	5	mA
	Applied voltage on CINT#, CT, RBIAS	-0.5 to 10	
CO	Applied voltage on SCL, SDA_I, SDA_O, INTB, A1, A2, A3, A4, A5, MS, PORB, WD_DIS, ALT_A/B, AC_LO, AC_HI	-0.5 to 6	V
1.0	Applied voltage on V48, P#, N#	-0.5 to 80	
Tj.	Junction operating temperature	-40 to 125	
T _{stg}	Storage temperature55 to 150	-55 to 150	°C
T _{sol}	Lead temperature (soldering, 10 sec.)	260	

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATINGS(1)

PACKAGE	THERMAL RESISTANCE JUNCTION TO CASE θ_{JC}	THERMAL RESISTANCE JUNCTION TO AMBIENT θ_{JA}		
PAP	0.38°C/W	21.47°C/W		
PJD	0.38°C/W	21.47°C/W		

Thermal Resistance measured using 2-oz copper trace and copper pad solder following layout recommendation in TI Publication PowerPAD Thermally Enhanced Package Technical Brief SLMA002.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

PARAMETER				MIN	NOM	MAX	UNIT
V _{IN}	W.100 P. COM. T.	Input voltage, V48 pin	COM	21.5	48	57	V
TJ	WW. 11007.0M.T	Junction temperature	MOD	-40	W	125	°C

ELECTRO STATIC DISCHARGE (ESD) PROTECTION

		MAX	UNIT
Human body model	CONT.	1.5	OM
CDM	M. 2N.1003. COW. 14	1 100 1	kV
Machine model	WW. 100X.COM.TW	0.2	

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⁽²⁾ All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal. Consult Packaging Section of the Data book for thermal limitations and considerations of packages.



ELECTRICAL CHARACTERISTICS

 $V48 = 48 \text{ V}, \text{ R}_{\text{T}} = 124 \text{ k}\Omega, \text{ C}_{\text{T}} = 220 \text{ pF}, \text{ C}_{\text{INT}} = 0.027 \text{ } \mu\text{F} \text{ (low leakage)}, -40^{\circ}\text{C to } 125^{\circ}\text{C} \text{ and } \text{T}_{\text{A}} = \text{T}_{\text{J}} \text{ (unless otherwise noted)}$

Power	Supply	THE WAY WE SAY TO	N			
Mo	V48 quiescent current	Off mode (all ports)	4	9	12	mA
	V48 quiescent current	Powered mode (all ports)		10	14	
COr	V10, internal analog supply	I _{LOAD} = 0	9.75	10.5	11.5	V
J CO	V3.3, internal digital supply	I _{LOAD} = 0 to 3 mA	3	3.3	3.7	v
C(V3.3 short circuit current	V = 0	3		12	mA
M.	V6.3, internal supply	I _{LOAD} = 0	5	6.3	7	
WY.C	V2.5, internal reference supply	I _{LOAD} = 0	2.46	2.5	2.54	1
and.	V _{UVLO_R} , V48 UVLO	Input voltage rising	16.0	W	21.5	V
Ino	V _{UVLO_F} , V48 UVLO	Input voltage falling	14	W	21	1
100	V _{HYSUV} , UVLO hysteresis	Ing. COM.	0.2	1.0	2.0	1
~ 10°	Internal POR time out(I ² C)	After all supplies are good I ² C activity is valid	MODI	8		Clock
W.10	Internal POR time out (Port)	After all supplies are good Port active to I ² C commands	A CO	66000		Clock Pulses
Port D	Discovery	M 1001. COM. THE WIN 100		W.I.		
MA.	Port off #P to #N input resistance	THE WILLIAM THE	400	600	, \	kΩ
TWW	Discovery open circuit voltage	WW. CON TW WWW	ONY.C	22	30	
-74	Discovery 1 voltage loop control	70 μA < I _{PORT} < 3 mA	2.8	4.4	TW	V
MA	Discovery 2 voltage loop control	70 μA < I _{PORT} < 3 mA	700	8.8	10	1
WW	Discovery current limit	P = N = 48 V	3	4	5	mA
W	Auto-mode discovery resistance acceptance Band	WWW.TOOX.COM.TW WW	19	M.CO.	26.5	N
	Auto-mode discovery resistance low end rejection	MAM. TOO Y. COW. TAN M.	00	OOX.CC	15	kΩ
	Auto-mode discovery resistance high end rejection	WWW.100X.COM.TW	33	100Y.C	OM	WT
	Discovery1,2 A/D conversion scale factor	100 μA < I _{PORT} < 3 mA	5.30	6.10	6.75	count/μ/
	Discovery1,2 A/D conversion time	I _{PORT} = 120 μA		W.100		ms
Port C	Classification	WWW.100Y.Coll.TW	MA	100	7.0	MT
	Classification voltage loop control	100 μA < I _{PORT} < 50 mA	15	17.5	20	V
	Classification current limit	P = N = 48 V	50	60	100	COME
	Class 0 to 1 detection threshold	14. COM-	5.5	6.5	7.5	COM
	Class 1 to 2 detection threshold	TW WY TIOOK OM.TH	13	14.5	16	m A
	Class 2 to 3 detection threshold	WWY CONV.CO	21	23	25	mA
	Class 3 to 4 detection threshold	N. TOWN. TOWN. TOWN.	31	33	35	NY.CU
	Class 4 to 0 detection threshold	WILL MANNION COM.	45	48	51	C'
	Classification A/D conversion scale factor	OW.TW WWW.1007.COW.	375	424	475	Count/n
	Classification A/D conversion time	I _{PORT} = 50 mA	- AN	18	22	ms
	MMM 100A	COWILM MAMNIOON CON	LTW		MAA	N.100

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ELECTRICAL CHARACTERISTICS (continued)

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 $V48 = 48 \text{ V}, \text{ R}_{\text{T}} = 124 \text{ k}\Omega, \text{ C}_{\text{T}} = 220 \text{ pF}, \text{ C}_{\text{INT}} = 0.027 \text{ } \mu\text{F} \text{ (low leakage)}, -40^{\circ}\text{C to } 125^{\circ}\text{C} \text{ and } \text{T}_{\text{A}} = \text{T}_{\text{J}} \text{ (unless otherwise noted)}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Port Le	egacy Detection					
OM.	Legacy current limit	P = N = 48 V	2.6	3.5	4.3	mA
CO_{M}	Legacy voltage A/D conversion scale factor	100 mV < V _{PORT} < 17.5 V	1365	1400	1445	Count/\
1 CO	Legacy A/D conversion time	0 V < V _{PORT} < 15 V	TW	18	22	ms
Port P	owered Mode	COMPT	VI.			
N.C.	Port on resistance	20 mA < I _{PORT} < 300 mA	$M_{I,I}$	1.3	1.8	Ω
I _{CUT}	Over current threshold	$R_{BIAS} = 124 \text{ k}\Omega, C_T = 220 \text{ pF},$	570	615	665	
I _{LIM}	Output current limit	W.COM. TW WWW. ONY.C	600	650	700	
I _{LIM} - I _{CUT}	Threshold delta	MOX.COM.TW WWW.M	2	W	70	mA
.10	Disconnect timer current threshold	$R_{BIAS} = 124 \text{ k}\Omega, C_T = 220 \text{ pF}$		7.5	10	
T_{MPDO}	Disconnect detection time	I_{LOAD} < current threshold, R_{BIAS} = 124 k Ω , C_T = 220 pF	300		400	ms
111.5	Port output UV	100X.CO.TW WWW.10	42.0	42.7	44.0	V
MM^{-1}	Port output OV	M. T. COM. THE WAY.	54	55	56	V
T _{OVLD}	Over current time out	$R_{BIAS} = 124 \text{ k}\Omega, C_T = 220 \text{ pF}$	50	O_{Mr}	75	
T _{LIM}	Short circuit time out	RBIAS = 124 k., CT = 220 pF	50	OM.	75	ms
WW	Turnoff delay from UV/OV faults	RBIAS = 124 k., CT = 220 pF, After port enabled and ramped up	100x.	CO 3.	TW	ms
W.	Port current A/D conversion scale factor	20 mA < I _{PORT} < 56 V	31	36.41	40	Count/n A
	Port current A/D conversion time	I _{PORT} < 300 mA	1111	18	22	ms
1	Port voltage A/D conversion scale factor	45 V < V _{PORT} < 56 V	335	353	370	Count/\
	Port voltage A/D conversion time	WWW. CON. COM. TW	MAN A.	18	22	ms
	Port temperature A/D conversion	COM. Too COM.	(1750	0 - counts	s)/16	°C
Port D	isable Mode	M. 100 . COM.	TAN V	1.700	1 CO	1. 1
	Port N voltage	P = 48 V	47	N.100	y	V-V
AC LO	and AC HI Specification	N.M. TOOX.CO. T.W.	MM	1100	N.C.	TIME
	AC_LO, AC_HI – low output voltage	OI MAN TO ON COMP.	0	1111	0.5	Uh-
	AC_LO – high output voltage	WW.100 COM.	3.0		5.0	OV
	AC_HI – high output voltage	M. 1002. William	5.0	-111	7.0	

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ELECTRICAL CHARACTERISTICS (continued)

V48 = 48 V, R_T = 124 k Ω , C_T = 220 pF, C_{INT} = 0.027 μ F (low leakage), -40°C to 125°C and T_A = T_J (unless otherwise noted)

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- 1 T	PARAMETER	TEST CONDITIONS	MIN TYP MAX	UN
Digital	I I ² C DC Specifications	MAN TONY CO	TW	
CO_{M}	SCL, SDA_I, A1–A5 ,WD_DIS, ALTA/B, MS, PORB logic input threshold	OWITH MAMY TOOK COM	1.5	١
~ ~ ~ ~	SCL, SDA_I input hysteresis	COM.	250	
	MS, PORB input hysteresis	. CON. TV	150	m
Y.C	WD_DIS, ALTA/B, MS, PORB input pulldown resistance	Input voltage 0.5 to 3 V	50	k
10.X.c	A1-A5 pull-down current	01. COM: IA. W. MAN. 100	10	μ
noY.	SDA_O logic high leakage	Drain = 5 V	100	n
10	SDA_O logic low	I _{SINK} = 10 mA	200	m
700	INTB logic high leakage	Drain = 6 V	CO 10	μ
N.100	INTB logic low	I _{SINK} = 10 mA	200	n
Digital	I I ² C Timing	N 100Y. COM.TW	TOO I. CON'I A.	
Miss	SCL clock frequency	WW.	0 400	kl
MW.	Pulse duration	SCL high	0.6	
TV	ruise duration	SCL low	1.3	
	Rise time, SCL to SDA	W.1001.	0.300	
WW.	Fall time, SCL to SDA	THE THE THE THE THE	0.300	
WW	Setup time, SDA to SCL	WWW. TOOX.CO. TW. W.	0.250	
-11	Hold time, SCL to SDA	MANA CONT.	0.300 0.900	Ì
	Bus free time between start and stop	M. Too E COM. I	1.3	
V	Setup time, SCL to start condition	W" 1001. OM.TW	0.6	
	Hold time, start condition to SCL	MM. TOOX.CO.TITW	0.6	
	Setup time, SCL to stop condition	MANN STORY COME	0.6	

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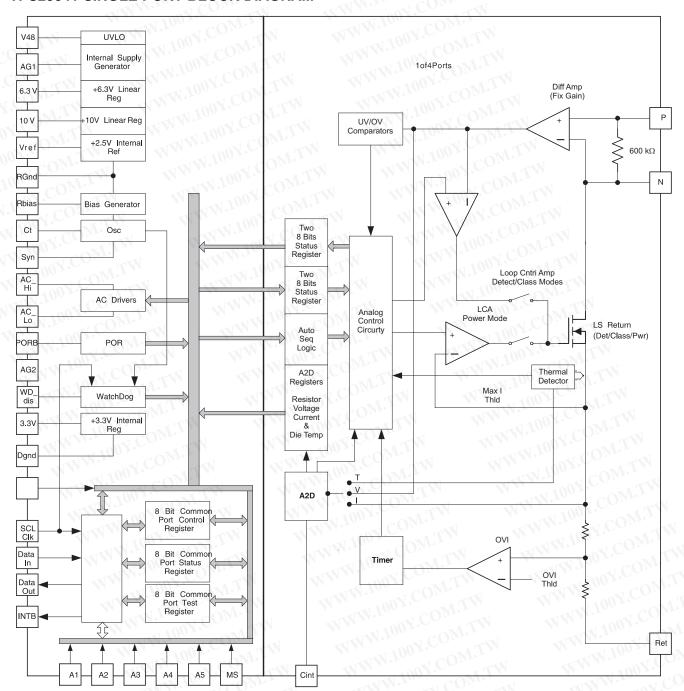
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TPS23841 SINGLE PORT BLOCK DIAGRAM





TERMINAL FUNCTIONS

	ERMINAL		100	COM. I COM. I COM. I	
NAME NO.		- NA - 1 - 1	1/0	DESCRIPTION	
			N.2	WAY CONTRACTOR TO THE STATE OF	
POWER A	AND GRO	JND	W.7.	10 V 10 V 10 V 10 do inc. This county and have a page of 20 V to E7 V. This pin should be decounted	
V48	60	5	WW.	48-V input to the device. This supply can have a range of 22 V to 57 V. This pin should be decoupled with a 0.1-μF capacitor from V48 to AG1 placed as close to the device as possible.	
V10	58	7	0	10-V analog supply. The 10-V reference is generated internally and connects to the main internal analog power bus. A 0.1-μF de-coupling capacitor should terminate as close to this node and the AG1 pin as possible. Do not use for an external supply.	
V6.3	59	6	0	6.3-V analog supply. A $0.1\text{-}\mu\text{F}$ de-coupling capacitor should terminate as close to this pin and the AG1 pin as possible. Do not use for an external supply.	
V3.3	24	41	0	3.3-V logic supply. The 3.3-V supply is generated internally and connects to the internal logic power bus. A 0.1-μìF de-coupling capacitor should terminate as close to this node and the DG pin as possible. This output can be used as a low current supply to external logic.	
V2.5	54	11	0	2.5-V reference supply. The V2.5 is generated internally and connects to the internal reference power bus. This pin should not be tied to any external supplies. A 0.1 - μ F de-coupling capacitor should terminate as close to this node and the RG pin as possible. Do not use for an external supply.	
AG1	57	8	GND	Analog ground 1. This is the analog ground of the V6.3, V10 and V48 power systems. It should be externally tied to the common copper 48-V return plane. This pin should carry the low side of three de-coupling capacitors tied to V48, V10 and V6.3.	
AG2	61	4	GND	Analog ground 2. This is the analog ground which ties to the substrate and ESD structures of the device. It should be externally tied to the common copper 48-V return plane. AG1 and AG2 must be tied together directly for the best noise immunity.	
DG	23	42	GND	Digital ground. This pin connects to the internal logic ground bus. It should be externally tied to the common copper 48-V return plane.	
RG	56	(C9)	GND	Reference ground. This is a precision sense of the external ground plane. The integration capacitor (CINT) and the biasing resistor (RBIAS pin) should be tied to this ground. This ground should also be used to form a printed wiring board ground guard ring around the active node of the integration capacitor (CINT). It should tie to common copper 48-V return plane.	
PORT AN	ALOG SI	SNAL	Mi	TAIN TOO TO THE TAIN TO A COMPANY	
P1	7	58	M	Port Positive. 48-V load sense pin. Terminal voltage is monitored and controlled differentially with	
P2 \(\)	10	55	L		
P3	39	26	CQ "	respect to each Port N pin Optionally, if the application warrants, this high side path can be protected with the use of a self resetting poly fuse.	
P4	42	23	COZ	TWO SEE STATE OF THE TOTAL TOT	
N1	6	59	L	W.J.A. A. TOO Y. COM. J. T. M.M. Lan. A. COM.	
N2	11	54		Port negative. 48-V load return pin. The low side of the load is switched and protected by internal	
N3	38	27	1.C	circuitry that will limit the current.	
N4	43	22		CONTRACTOR WIN THE TWO WIN THE TONK COM	
RET1	5	60	No.	COMPANIE OF COMPAN	
RET2	12	53	100,	TOWN TOWN TOWN TOWN TOWN TOWN TOWN TOWN	
RET3	37	28	1100	48 V return pin	
RET4	44	21	T.	W.COM TW WWW. 100Y.CO. LTW WW. 100Y.CO.	
	4	61	Mire	COMPANDED COMPAND COMP	
CINT1	13	52	KT (1)	Integration capacitor. This capacitor is used for the ramp A/D converter signal integration. Connect A 0.027- μF capacitor from this pin to RG. To minimize errors use a polycarbonate, poly-polypropylene	
CINT1 CINT2			44.7.	polystyrene or teflon capacitor type to prevent leakage. Other types of capacitors can be used with	
	36	29	Lati	increased conversion error.	

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TERMINAL FUNCTIONS (continued)

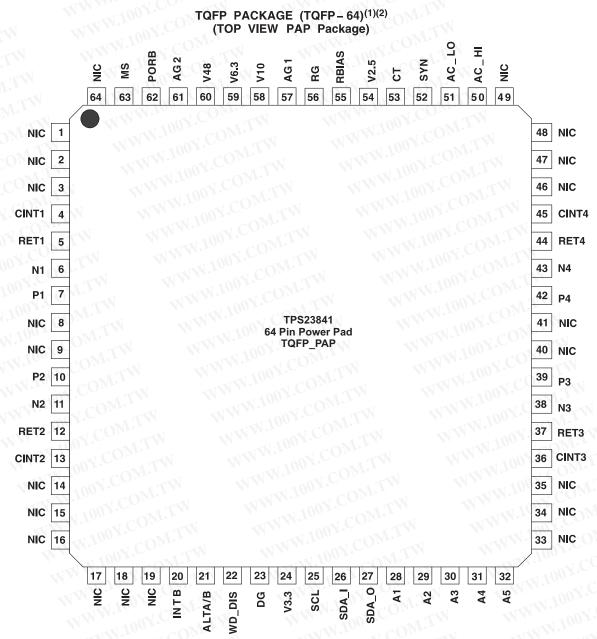
	ERMINAL	NO.		DESCRIPTION		
NAME PAP			I/O	DESCRIPTION		
)// - 12	_	PJD	W	MY COM WY THOY COMEN		
ANALOG	SIGNALS	3		T-SV-COM-		
			WW	This is a dual-purpose pin. When tied to an external capacitor this pin sets the internal clock. When the CT pin is grounded the SYN pin turns from a output to an input (see SYN pin description)		
CT.OM.	53	12	WW	The timing capacitor and the resistor on the RBIAS pin sets the internal clock frequency of the device. This internal clock is used for the internal state machine, integrating A/D counters, POR time out, faults and delay timers of each port. Using a 220-pF capacitor for CT and a 124-k Ω resistor for RBIAS sets the internal clock to 245 kHz and ensure IEEE 802.3af compliance along with maximizing the rejection of 60-Hz line frequency noise from A/D measurements.		
RBIAS	55	N 10	I,	Bias set resistor. This resistor sets all precision bias currents within the chip. This pin will regulate to 1.25V (V2.5/2) when a resistor is connected between RBIAS and RG. This voltage and RBIAS generate a current which is replicated and used throughout the chip. This resistor also works in conjunction with the capacitors on CT and CINT to set internal timing values. The RBIAS resistor should be connected RG. RBIAS is a high impedance input and care needs to be taken to avoid signal injection from the SYN pin or I ² C signals.		
SYN	52	13	I/O	This is a dual purpose pin. When the CT pin is connected to a timing capacitor this output pin is a 0 to 3.3V pulse of the internal clock which can be used to drive other TPS23841 SYN pins for elimination of a timing capacitor. When the CT pin is grounded this pin becomes an input pin that cabe driven from a master TPS23841 or any other clock generator signal.		
AC_LO	51	14	0	Totem-pole output pin for AC Disconnect excitation.		
AC_HI	50	15	No	Totem-pole output pin for AC Disconnect excitation.		
DIGITAL S	SIGNALS	OM.,		MAN TO SO TO THE MAN TO THE TANK		
SCL	25	40	L	Serial clock input pin for the I ² C interface.		
SDA_I	26	39	TY	Serial data input pin for the I ² C interface. When tied to the SDA_O pin, this connection becomes the standard bi-directional serial data line (SDA)		
SDA_O	27	38	0	Serial data open drain output for the I ² C interface. When tied to the SDA_I pin, this connection becomes the standard bi-directional serial data line (SDA). This is a open drain output that can directly drive opto-coupler.		
WD_DIS	22	43	OM.	The WD_DIS pin disables the watchdog timer function when connected to 3.3 V. The pin has intern 50-k. resistor to digital ground. The watchdog timer monitors the I ² C clock pin (SCL) and the internal oscillator activity in power management mode and only the internal oscillator activity in auto mode.		
INTB	20	45	0	This is an open-drain output that goes low if a fault condition occurs on any of the 4 ports.		
ALTA/B	21	44	N.E	When this input is set to logic low there is no back-off time after a discovery failure. When this pin s to a logic high there is a back-off time (approximately 2 seconds) before initiating another discovery cycle. This pin has an internal $50-k\Omega$ resistor pull-down to digital ground.		
A1	28	37	1.0	THE WAY TOOK OF THE WAY TOOK ON!		
A2	29	36	L	Address 1 through 5 These are the I ² C address select inputs. Select the appropriate binary address		
А3	30	35	0012	on these pins by connecting to the chip ground for a logic low or tying to the V3.3 pin for a logic hig		
A4	31	34	100	Each address line has an internal current source pull-down to digital ground.		
A5	32	33	100	NOTELLA MALTONIONINA MALTONIONIO		
MS	63	2	M.T.	The MS pin selects either the auto mode (MS low) or the power management mode, PMM, (MS high). This pin can be held low for controller-less standalone applications. When MS is low and the POR timing cycle is complete the chip will sequentially <i>Discover, Classify and Power on</i> each port. When MS is set high the ports are controlled by register setting via the I^2C bus. The MS pin has an internal 50 -k Ω resistor pull-down to analog ground.		
PORB	62	3		This pin can be used to override the internal POR. When held low, the I^2C interface, all the state machines, and registers are held in reset. When all internal and external supplies are within specification, and this pin is set to a logic high level, the POR delay will begin. The I^2C interface an registers will become active within 70 μ s of this event and communications to read or preset register can begin. The reset delay for the remainder of the chip then extinguishes in 1 second. This pin has an internal 50-k Ω resistor pull-down to analog ground.		

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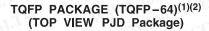


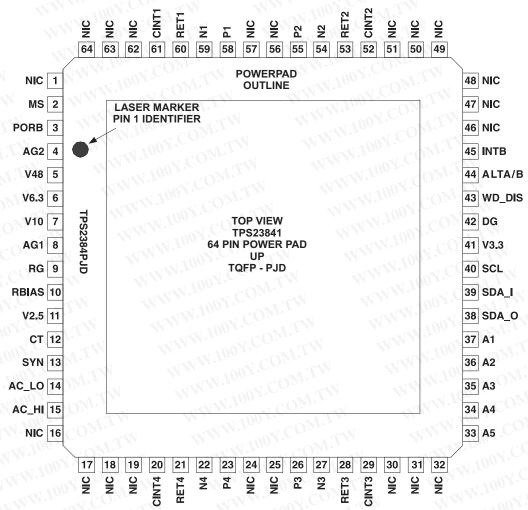
CONNECTION DIAGRAM



- (1) NIC = No internal connection. Pins are floating.
- (2) NIC pins can be tied to the ground plane for improved thermal characteristics and to prevent noise injection from unused pins.
- (3) NIC pins next to CINT pins should be tied to ground to prevent noise injection into A/D converter.







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AUTO MODE FUNCTIONAL DESCRIPTION

Auto Mode

Auto mode (AM, MS = 0) operation is the basic approach for applying power to IEEE compliant PD's. When AM has been selected the TPS23841 automatically performs the following functions:

- Discovery of IEEE 802.3af compliant powered devices (PD's)
- Classification
- Power delivery
- Port over/under voltage detection, (if enabled, see Over/Under Voltage Fault section)
- Port over current detection (570 mA < I_{PORT} < 665 mA
- Port maximum current limit (600 mA < I_{PORT} < 700 mA)
- DC Disconnect (5 mA < I_{PORT} < 10 mA)
- Thermal shutdown protection (TSD), (T_J > 150°C)
- Internal oscillator watchdog

In AM the contents of all read registers are available via the I²C interface. In addition all control registers except for the function bits can be written. This supports a semi-auto mode where the TPS23841 auto detects compliant PD's while a host can access the A/D registers and class information and then implement power management (including turning a port off, responding to faults, etc).

The write registers that are still active in AM are:

- All ports disable Common Control register 0001b
- Over/Under Voltage Faults Common Control register 0001b
- Software reset Common Control register 0001b
- Disconnect disable Port Control 1 register 0010b
- Discovery fault disable Port Control 1 register 0010b
- Port enable Port Control 2 register 0011b

For alternative B, semi-auto mode implementations which will manipulate the all ports disable or Port Enable bits, please contact the factory for additional application information.

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Auto Mode Functional Description

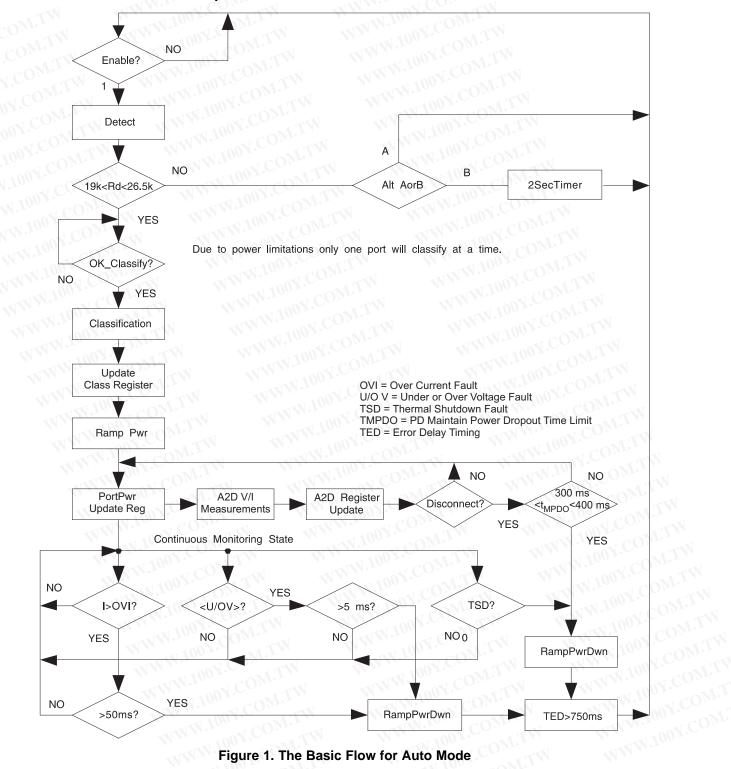


Figure 1. The Basic Flow for Auto Mode



AM Discovery

The TPS23841 uses a four-point measurement technique using two low level probe signals (typically 4.4 V and 8.8V) during the discovery process to determine whether a valid PD is present. The use of a multipoint detection method for the PD resistor measurement allows accurate detection even when series steering diodes are present. The low level probe voltages also prevent damage to non-802.3 devices. When a valid PD has been detected the TPS23841 moves to classification. If a valid PD has not been detected the TPS23841 continues to cycle through the discovery process. The waveform in Figure 2 shows typical N-pin waveforms for the discovery of a valid PD and the failure to discovery due to a discovery resistor of 15 k Ω and 33k Ω .

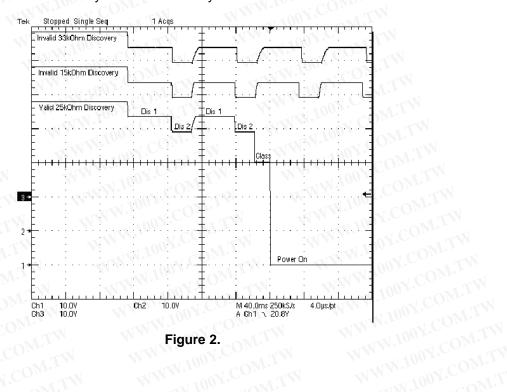


Figure 2.

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AM Classification

After a successful discovery of a valid PD the TPS23841 enters the classification function that identifies the power level based on the PD's current signature. The classification current level is measured at a reduced terminal voltage of 17.5V. During classification the power dissipation can be at its highest; therefore, to prevent over temperature shutdown in automode only one port classifies at a time. When multiple ports successfully discover and proceed to classification at the same time the auto sequencer processes each request separately allowing only one port to enter classification. Figure 3 shows all 4 ports successfully detecting a valid PD at the same time and than the classification of each port occurring separately.

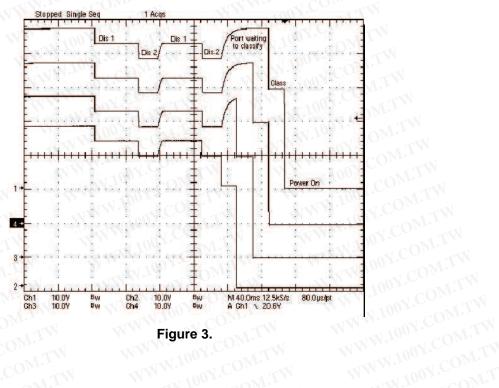


Figure 3.

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Upon completion of classification the port classification register is updated. In AM mode this information is not used but for semi-auto mode the class information can be used for power management. Figure 4 shows actual class currents and the class assignment which were stored in the register. These assignments are compliant with the IEEE 802.3af Standard

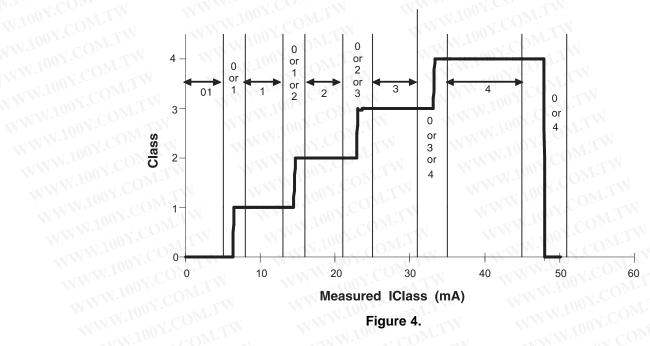


Figure 4. WWW.100Y.CO.

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AM Power Delivery

After successfully discovery and classification of a valid PD the power is delivered by controlling the current to the PD until its current requirements are met or until the internal current limit is reached (approximately 650 mA). The power switch is fully enhanced after 500 µs. Figure 5 show the voltage and the current that is being applied to the PD during power-up and reaching the PD load of 250mA.

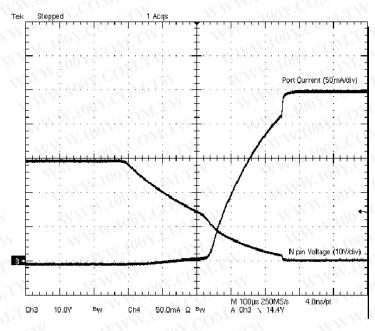


Figure 5.

After power has been applied to the PD the TPS23841 automatically enters the current and voltage sample mode. The sample mode performs 31 current measurements and 1 voltage measurement. Each measurement takes approximately 18 ms to complete. The port remains powered and the current/voltage measurement cycle continues until a fault condition occurs. The current and voltage measurements are both stored in the A/D current and voltage registers and can be accessed through the I²C pins. This allows power management in the AM if it is desired.

AM Faults and INTB Output

AM faults are:

- Port under and over voltage faults, (if enabled, see Over/Under Voltage Fault section)
- Over current faults
- Under current (DC Disconnect) fault
- Thermal shutdown (TSD) fault
- Watchdog timer faults (disabled via WD_DIS pin)

Any one of the first four fault conditions listed above causes the port to shut down, and a 3-bit fault code to be latched into the affected port's Status Read 1 register (addr = 0100b). Watchdog faults cause all four ports to shut down. Faulted ports are temporarily disabled after a fault has been detected and latched.

The INTB pin is an open-drain, active-low output which is asserted if a fault condition occurs on any of the four ports. This indication is asserted for any of the port faults which result in a code displayed in the port status register (the faults listed in Table 8). In automode, the fault latch, the status register fault bits, and consequently, INTB assertion, are cleared by expiration of the 750-ms TED timer.



Over/Under Voltage Fault

For the TPS23841, port over and undervoltge detection is disabled by default after device POR. This continuous voltage monitoring feature can subsequently be enabled by writing a logic 1 to bit D2 in the Common Control register, assuming usage under the direction of a higher level controller, (i.e., usage in semi-auto mode).

Over/under voltage faults are only processed after port power up has completed (voltage/power ramp to PD is done). The TPS23841 measures the voltage between the P and N pin and if this voltage drops below the under voltage threshold (typically 43 V) or increases above the over voltage threshold (typically 55 V) the voltage timer is turned on. When the voltage timer reaches its time-out limit that is set between 2 ms to 5 ms the corresponding port is turned off and the UV/OV fault code generated in the Port Status 1 register. If the over/under voltage condition is removed prior to the voltage timer reaching its limit the timer is reset and waits for the next event. Figure 6 shows a voltage fault lasting for more then 2 ms that has caused the port to shutdown.

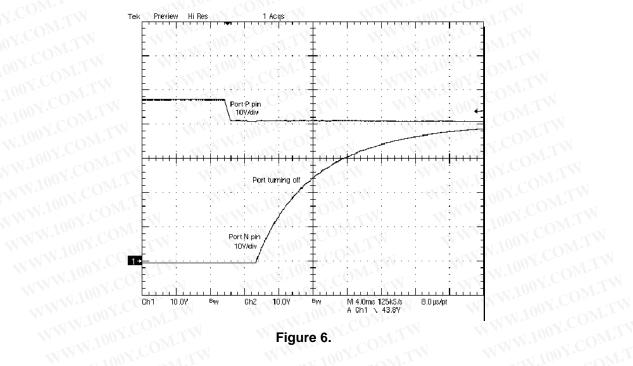


Figure 6.

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Over Current or Current Limit Faults

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Over current or current limit faults are conditions when the load current that is being sensed trips either the I_{CLT} comparator (570 mA to 665 mA) or the I_{IIM} comparator (600 mA to 700 mA) and turns on the current fault timer. When the over current timer reaches its time out limit that is set between 50 ms to 75 ms the corresponding port is turned off and the over current fault code generated in the Port Status 1 register. If the over current condition goes away prior to the over current timer reaching its limit the timer is reset and waits for the next event. Figure 7 shows an over current fault lasting more than 50 ms that has caused the port to shut off.

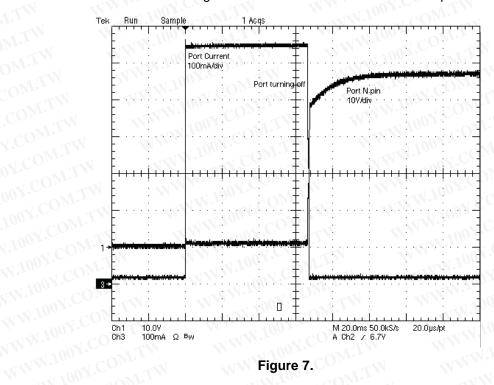


Figure 7.

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Under Current Fault (DC Modulated Disconnect)

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Under current fault (dc modulated disconnect) is a condition when the load current that is being measured drops below 7.5mA and turns on the disconnect timer. If the disconnect timer reaches its time out limit that is set between 300ms to 400ms the corresponding port is turned off and the load disconnect fault code generated in the Port Status 1 register. If the under current condition goes away prior to the disconnect timer reaching its limit the timer is reset and the port remains powered.

Figure 8 shows DC Disconnect event. In this setup the load current was set right above the 7.5mA threshold. The duty cycle of the load was then adjusted until the off period exceeded the disconnect time out, causing turn-off of the port. The time-out period was > 300 ms.

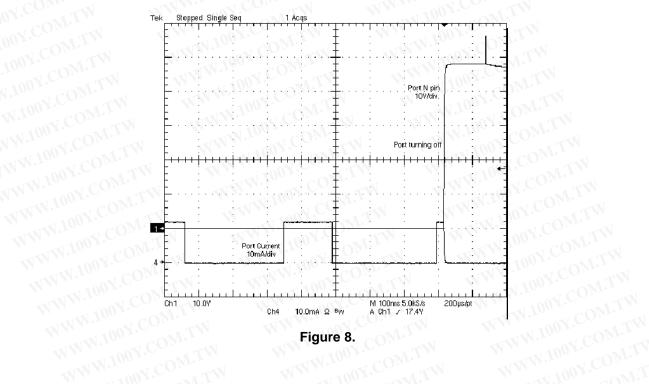


Figure 8.

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POWER MANAGEMENT MODE FUNCTIONAL DESCRIPTION

Power Management Mode (PMM)

Power management mode (PMM) has been designed to work efficiently with simple low-cost microcontrollers such as those in the MSP430 family.

The power management mode uses 13 self-contained functions to completely control the device operation. You simply write/read through the I²C pins and wait for the function done bit to be set. If an A/D measurement was performed during the function the results can be accessed by going to the read mode and addressing the proper register.

13 Funcitons

- Disable: Disable the port and reset all functions.
- **Discovery 1:** Enable the Discovery 1 condition which applies a 4.4 V across the PD and measure and store the resulting current.
- **Discovery 2:** Enable the Discovery 2 condition which applies a 8.8 V across the PD and measure and store the resulting current.
- V Sample: Measure the voltage between the P and N pins and store the result in the A/D voltage register.
- Legacy: Enable the 3.5-mA current source formeasuring capacitance and measure the voltage across the P and N terminals and store the result in the A/D voltage register.
- Classify: Enable the classification condition which applies 17.7 V across the PD and measure and store the resulting current.
- Rup Pwr: Turn on the output switch while controlling the current being delivered to the PD until the PD current needs are met or the max current is reached.
- C Sample: Continuous cycle of 31 current measurements and 1 voltage measurement. After each measurement the contents of the appropriate register are updated.
- Rdwn: Turn off the output switch while controlling current until output current reaches 0 mA.
- AC LO: Turns on low side output FET and measures voltage between P and N pin and store result in A/D voltage registers.
- AC HI: Turns on high side output FET and measures voltage between P and N pin and store result in A/D voltage registers.
- ISample: Measure the current and store the result in the A/D current register.
- TSample: Measure the internal die temperature and store the result in the A/D temperature register.

Conversion times for A/D measurements performed as part of the functions listed above are generally as shown in the typical values in the Electrical Characteristics table. However, conversion time is somewhat dependant on the magnitude of the input signal being measured. Power management mode applications should take precautions to test the A/D DONE bit (MSB of the high byte) of the pertinent results register before accepting or using the returned value. A logic 1 at this bit location indicates the conversion is complete. Also, once an A/D conversion is in process on a given port, subsequent function calls to that port should wait until the currently executing conversion is complete. Commands written prior to completion may cause the results of the initial conversion to be written to the register of the subsequent function.

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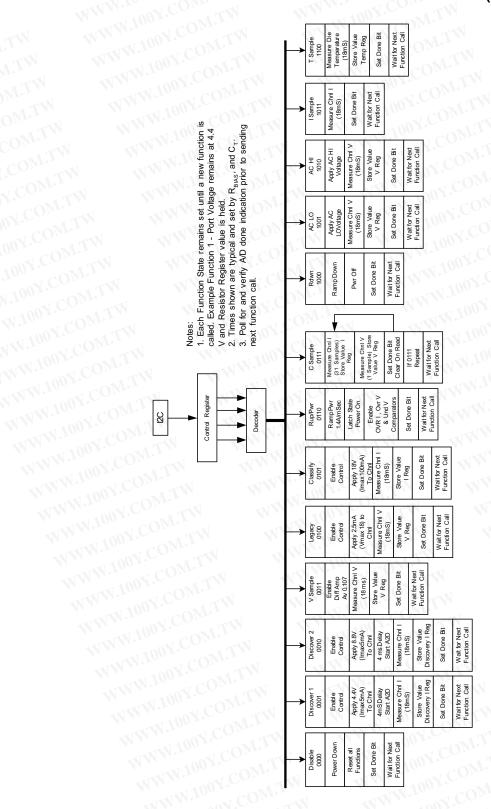


Figure 9.



PMM Discovery 1

PMM Discovery 1 function waveforms for the N and CINT pins are shown in Figure 10. The measurement is being performed using 25 k Ω impedance between the P and N pin. The Discovery 1 voltage is allowed to settle for approximately 5ms before the A/D begins integrating. The voltage on the CINT pin shows the A/D cycle. There are four distinct regions to any A/D cycle: pre-charge (to a known starting voltage), charge, coarse discharge, and fine discharge. CINT pin is very high impedance therefore extreme care must be taken to avoid any noise or leakage affecting this pin. For the measurements where CINT voltage is shown a buffer was used to prevent performance degradation. The A/D measurement time is approximately 18ms. The entire Discovery 1 function takes approximately 22 ms to complete. At the end of the A/D cycle the Discovery 1 current is stored in the Discovery Current Register and the function done bit is set. The applied Discovery 1 voltage level remains until a new function is called. The data for this measurement will remain stored in the Discovery Current Register until another Discovery 1 or 2 function is called.

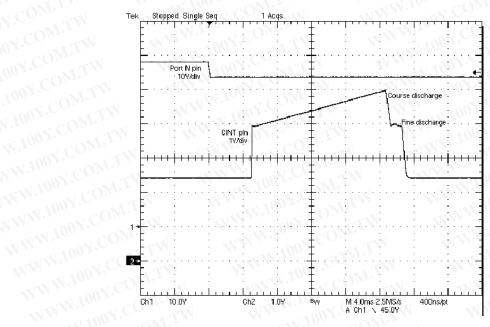


Figure 10.

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23



PMM Discovery 2

PMM Discovery 2 function waveforms for the N and CINT pins are shown in Figure 11. Again the measurement is being performed using $25 \text{ k}\Omega$ impedance between the P and N pin. The Discovery 2 function was called after a Discovery 1 function so the voltage ramps from 4.4 V to 8.8 V below the P pin. The Discovery 2 voltage is given 5 ms to settle before the A/D begins to integrate. At the end of the A/D cycle the Discovery 2 current is stored in the Port Discovery Current Register and the function done bit is set. The applied Discovery 2 voltage level will remain until a new function is called. The data for this measurement will remain stored in the Discovery Current Register until another Discovery 1 or 2 function is called.

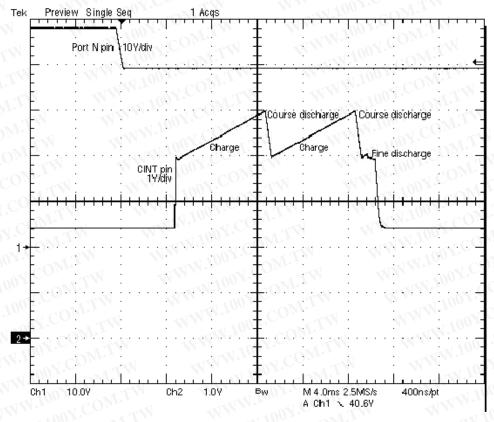


Figure 11.

PMM Classification

PMM Classification function looks similar to Discovery 1 and 2 except that the voltage between the P and N pins regulates to approximately 17.5 V. At the end of the A/D cycle the classification current is stored in the Port Current Register and the done bit is set. The applied classification level will remain until a new function is called. The data for this measurement remains stored in the Port Current Register until either the Classify or ISample function is called.

As indicated in the flow diagram of Figure 1, the TPS23841 in AM only performs classification at one port at a time. Similarly, PMM applications should take care to ensure that only one port per device is put into the classification mode at any one time to limit power dissipation in the package.



PMM Legacy

PMM Legacy function is used to detect PDs that are non compliant. Legacy detection uses a current source (typically 3.5 mA) as a test current while the A/D measures the average voltage for approximately 18 ms. The waveform shown in Figure 12 is the Legacy function charging a 10-μF capacitor. The capacitance charges to a value that is no greater than 20V below the P port voltage. As the capacitor is charging the A/D is accumulating counts in the voltage A/D register. Figure 13 shows the relationship between port capacitance and the number of counts. A user can characterize non-compliant PD's signatures and use the Legacy function to recognize these devices.

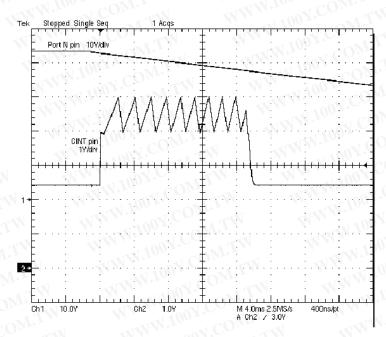


Figure 12.

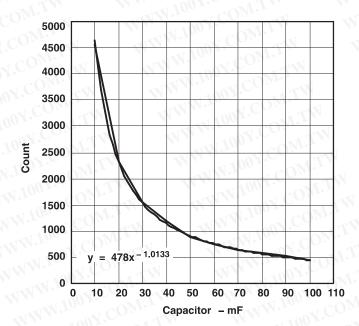


Figure 13.



PMM Rup Pwr

PMM Rup Pwr function turns on the port power by ramping up the current that is being delivered to the load in a controlled fashion. The output current ramps from 0 mA to I_{LIM} (typically 650 mA) in approximately 500 μ s. Figure 14 shows the output voltage and current turning on for a 250-mA load.

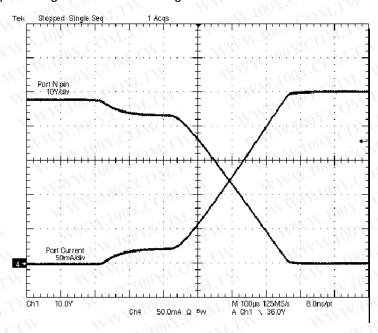


Figure 14.

PMM R_{DWN}

PMM R_{DWN} function turns off the port power by ramping down the current in a controlled fashion. The output current ramps from I_{LIM} (typically 650 mA) to 0mA in approximately 300 μ s. Figure 15 shows the output voltage and current shutting down for a 250-mA load.

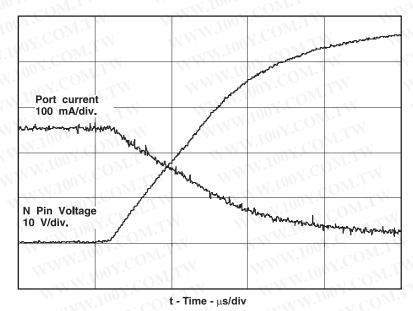


Figure 15.



Miscellaneous Functional Description

PMM Faults

PMM faults are the same as those shown in the AM Faults and INTB Output section. In PM mode, the port under- and over voltage and under-current faults can be enabled or disabled by writing to the control bits in the appropriate register. For the TPS23841, port under- and overvoltage detection is disabled by default after device POR or other reset operation. Under current detection, (DC Disconnect), is enabled by default. The enable state of these features can be toggled by writing to the corresponding control bit as defined in Table 5 and Table 6.

The PMM faults are:

- Port under- and over-voltage faults (enable/disable via Common Control register 0001b, bit D2)
- Overcurrent fault (cannot be disabled)
- Under-current (DC Disconnect) fault (enable/disable via Port Control register 0010b, bit D4)
- Thermal shutdown (TSD) fault (cannot be disabled)
- Watchdog fault (disable via WD_DIS pin)

Any one of these faults causes the port to shutdown. Once a fault has occurred the port can not be repowered until a Disable function is sent. The Disable function clears the fault latch and the fault register.

INTB pin operation is essentially the same in PMM as in AM, with the following exceptions:

- For load under-current to generate a fault shutdown and status indication, the condition of load current less than the threshold must be detected by the continuous sample (C SAMPLE) function (0111b).
- In PMM only, a Watchdog timer fault also asserts INTB.

Watchdog Timer

TPS23841 has two watchdog timers. One monitors the I^2C clock and the other monitors the internal clock. When automode is selected and the watchdog timer has not been disabled only the internal clock is monitored. When in power management mode and the watchdog timer has not been disabled then both the I^2C and internal clocks are monitored. If there is no I^2C clock activity for approximately two seconds then all ports are disabled. There are three means to enable ports after a I^2C clock fault and they are:

- 1. Hard power reset
- 2. PORB pulse
- 3. Writing a software reset to the Common Control register.

In both auto mode and power management mode if the internal oscillator is lost for more than 20 ms all ports are disabled.

Loss of these signals is considered catastrophic since the system loses its ability to talk to each port. Therefore the watchdog timers disabling all ports protects the system.

This function can be easily over ridden by setting the WD DIS pin high.



I²C Interface Description

The serial interface used in the TPS23841 is a standard 2-wire I²C slave architecture. The standard SDA line of the I²C architecture is broken out into independent input and output data paths. This feature simplifies earth grounded controller applications that require opto-isolators to keep the 48-V return of the Ethernet power system floating. For applications where opto-isolation is not required, the bidirectional property of the SDA line can be restored by connecting SDA I to SDA O. The SCL line is a unidirectional input only line as the TPS23841 is always accessed as a slave device and it never masters the bus.

Data transfers that require a data-flow reversal on the SDA line are 4-byte operations. This occurs during a TPS23841 port read cycle where a slave address byte is sent, followed by a port/register address byte write. A second slave address byte is sent followed by the data byte read using the port/register setup from the second byte in the sequence.

The I²C interface and the port read write registers are held in active reset until all input voltages are within specifications (V10, V6.3, V3.3 and V2.5) and the internal POR timer has timed out (see electrical specifications).

The I²C read cycle consists of the following steps 1 through 14 and is shown in Figure 16:

- 1. Start Sequence (S)
- 2. Device address field
- Write
- 4. Acknowledge
- 5. Register/Port address
- 6. Acknowledge
- 7. Stop
- 8. Start
- 9. Device address field
- 10. Read
- 11. Acknowledge
- Data Transfer
- 13. Acknowledge
- 14. Stop

Data write transfers to the TPS23841 do not require a data-flow reversal and as such only a 3-byte operation is required. The sequence in this case would be to send a slave device address byte, followed by a write of the port/register address followed by a write of the data byte for the addressed port.

The I²C write cycle consists of the following steps 1 through 9 and is also shown in Figure 16: WWW.100Y.COM.TV

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- 1. Start sequence (S)
- 2. Device address field
- 3. Write
- 5. Register/Port address6. Acknowled
- 6. Acknowledge
- Data for TPS23841
- 8. Acknowledge
- 9. Stop



Start/Stop

The high-to-low transition of SDA_I while SCL is high defines the start condition. The low to high transition of SDA_I while SCL is high defines the stop condition. The master device initiates all start and stop conditions.

The first serial packet is enclosed within start and stop bits, consists of a 7-bit address field, read/write bit, and the acknowledge bit. The acknowledge bit is always generated by the device receiving the address or data field. Five of the seven address bits are used by the TPS23841. The value of the sixth and seventh bit is ignored and not used by the TPS23841.

Chip Address

The address field of the TPS23841 is 8 bits long and contains 5 bits of device address select and a read/write bit as and two spare bits per Table 1. The leading two bits are not used and are reserved for future port expansion. The five device address select bits follow this plan. These bits are compared against the hard-wired state of the corresponding device address select pins (A1–A5). When the field contents are equivalent to the pin logic states, the device is addressed. These bits are followed by LSB bit, which is used to set the read or write condition (1 for read and 0 for write). Following a start condition and an address field, the TPS23841 responds with an acknowledge by pulling the SDA_O line low during the 9th clock cycle if the address field is equivalent to the value programmed by the pins. The SDA_O line remains a stable low while the 9th clock pulse is high.

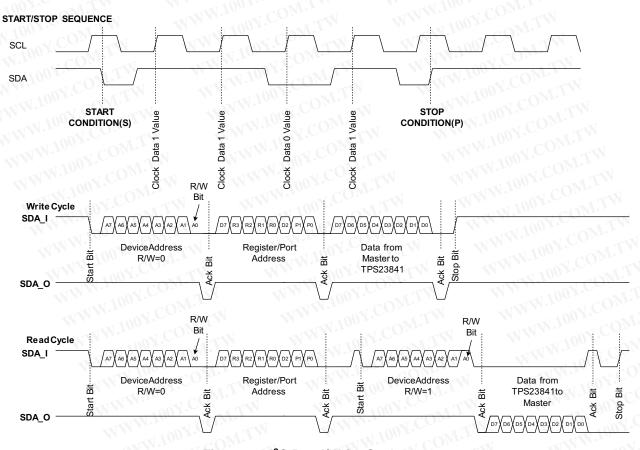


Figure 16. I²C Read/Write Cycles



Chip Addressing

Table 1 shows the bit assignments during the addressing cycle.

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Table 1. Address Selection Field

BIT	FUNCTION
A7	Future expansion (value not compared)
A6	Future expansion (value not compared)
A5	Device address. Compared with pin A5
A4	Device address. Compared with pin A4
А3	Device address. Compared with pin A3
A2	Device address. Compared with pin A2
A1	Device address LSB. Compared with pin A1
A0	Read/Write

Port/Register Cycle

After the chip address cycle, the TPS23841 accepts eight bits of port/register select data as defined in Table 2. The SCL line high-to-low transition after the eighth data bit then latches the selection of the appropriate internal register for the follow-on data read or write operation. After latching the eight-bit data field, the TPS23841 pulls the SDA O line low for one clock cycle, for the acknowledge pulse.

Data Write Cycle

For a data write sequence, after the Port/Register address cycle, the TPS23841 accepts the eight bits of data as defined in the tables below. The data is latched into the previously selected Write Register, and the TPS23841 generates a data acknowledge pulse by pulling the SDA O line low for one clock cycle. Common register functions act on all ports simultaneously. Per port registers are specific to the target port only.

To reset the interface, the host or master subsequently generates a stop bit by releasing the SDA I line during the clock-high portion of an SCL pulse.

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Data Read Cycles

For a data read sequence, after the register acknowledge bit, the master device generates a stop condition. This is followed by a second start condition, and re-transmitting the device address as described in chip address above. For this cycle, however, the R/W bit is set to a 1 to signal the read operation. The TPS23841 again responds with an acknowledge pulse. The address acknowledge is then followed by sequentially presenting each of the eight data bits on the SDA_O line (MSB first), to be read by the host device on the rising edges of SCL. After eight bits are transmitted, the host acknowledges by pulling the SDA I line high for one clock pulse. The completed data transfer is terminated with the host generating a stop condition.

Table 2. Register/Port Addressing Map

select MSB select Bit 2 select Bit 1	0001 = Common Co 0010 = Port Control 0011 = Port Control 0100 = Port Status F 0101 = Port Status F	ad - Port fault status, ntrol Write - Software Write 1 - Function cal Write 2 - Port enable; Read 1 - Fault status;	reset, ports disable ls; misc. fault disabl A/D control		0
select Bit 2	0001 = Common Co 0010 = Port Control 0011 = Port Control 0100 = Port Status F 0101 = Port Status F	ntrol Write - Software Write 1 - Function cal Write 2 - Port enable; Read 1 - Fault status;	reset, ports disable ls; misc. fault disabl A/D control		
_	0010 = Port Control 0011 = Port Control 0100 = Port Status F 0101 = Port Status F	Write 1 - Function call Write 2 - Port enable; Read 1 - Fault status;	s; misc. fault disabl A/D control		
select Bit 1	0011 = Port Control 0100 = Port Status F 0101 = Port Status F	Write 2 - Port enable; Read 1 - Fault status;	A/D control	LOOY.COM.TW	
M.TW	0101 = Port Status F		device Class info		
select LSB	0111 = Discovery Ci 1000 = Voltage-Low 1001 = Voltage - Up 1010 = Current - Low 1011 = Current - Up 1100 = Temperature 1101 = Temperature 1110 = unused	urrent - Lower Bits - A urrent - Upper Bits - A er Bits - A/D voltage r per Bits - A/D voltage wer Bits - A/D current per Bits - A/D current e - Lower Bits - A/D ter e - Upper Bits - A/D ter	other status //D resistance result: //D resistance result: esits results results results mperature results mperature results	MM.100X.COM.TA MN.100X.COM.TA M.100X.COM.TA	0000
	0				0
ess MSB	00 = port 1	M.M. CO.	WTS	MM	00
ess LSB	01 = port 2 10 = port 3 11 = port 4				M.TW
	ess MSB	1001 = Voltage - Up 1010 = Current - Lov 1011 = Current - Up 1100 = Temperature 1101 = Temperature 1110 = unused 1111 = Common Wr 0 Pass MSB 00 = port 1 01 = port 2 10 = port 3	1001 = Voltage - Upper Bits - A/D voltage 1010 = Current - Lower Bits - A/D current 1011 = Current - Upper Bits - A/D current 1100 = Temperature - Lower Bits - A/D ter 1101 = Temperature - Upper Bits - A/D ter 1110 = unused 1111 = Common Write - Test mode select 0 225 MSB 00 = port 1 01 = port 2 10 = port 3	1011 = Current - Upper Bits - A/D current results 1100 = Temperature - Lower Bits - A/D temperature results 1101 = Temperature - Upper Bits - A/D temperature results 1110 = unused 1111 = Common Write - Test mode selections - timer disables 0 28ss MSB 00 = port 1 01 = port 2 10 = port 3	1001 = Voltage - Upper Bits - A/D voltage results 1010 = Current - Lower Bits - A/D current results 1011 = Current - Upper Bits - A/D current results 1100 = Temperature - Lower Bits - A/D temperature results 1101 = Temperature - Upper Bits - A/D temperature results 1110 = unused 1111 = Common Write - Test mode selections - timer disables, discovery control, etc. 0 28ss MSB 00 = port 1 01 = port 2 10 = port 3

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Table 3. Common Read, Register Select = 0000

BIT	FUNCTION	COM.TW WWW.10 STATE	PRESET STATE
D7	Port 4 general Fault status	0 = no fault $1 = \text{port fault}^{(1)(2)}$	0
D6	Port 3 general Fault status	0 = no fault $1 = \text{port fault}^{(1)} (2)$	0
D5	Port 2 general Fault status	0 = no fault 1 = port fault (1) (2)	0
D4	Port 1 general Fault status	0 = no fault 1 = port fault ⁽¹⁾ ⁽²⁾	0
D3 D2	Chip rev	00 = rev - 01 = rev 1 10 = rev 2 11 = rev 3	00
D1 D0	Chip ID	00 = TPS23841 01 = future use 10 = TPS2384 11 = reserved	00

- (1) PMM faults cleared by Disable function.
- (2) AM faults cleared by TED timer.

Table 4. Common Write, Register Select = 1111 (Test Register)⁽¹⁾

BIT	FUNCTION	STATE WWW.1007.COM. STATE	PRESET STATE
D7	Unused	o COM. TO TOWN	0
D6	Thermal shutdown test	0 = normal operation 1 = force TSD condition (all ports off)	0
D5	POR disable	0 = normal POR timing 1 = force POR to a non-reset state	TWO
D4	Discovery timers	0 = normal (4-ms Discovery 1 and Discovery 2) 1 = timers disable	1.1.0
D3	Discovery 1 and 2	0 = normal operation 1 = all 4-port Discovery 1 and Discovery 2 – halt	011.0
D2	DC Disconnect timer	0 = DC Disconnect timer between 300 ms to 400 ms for loads less than 5 mA (IEEE standard) 1 = DC Disconnect timer 0 ms for loads less than 5 mA	COM
D1	TED timer	0 = normal operation 1 = 750-ms TED timer disable	LCOOL.
D0	Unused	O COMPANY THIN THE TOTAL COMPANY	CO

⁽¹⁾ Test mode select; not intended for end--application use.

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Table 5. Common Control Write, Register Select = 0001

BIT	FUNCTION	STATE	PRESET STATE
D7	Unused	O ONLY	0
D6	Unused	O WITH WITH 100X- OWITH	0
D5	Thermal shutdown fault ⁽¹⁾	0 = active 1 = disable	0
D4	AC high	0 = off 1 = AC_HI driver on	0
D3	AC low	0 = off 1 = AC_LO driver on	0
D2	Port over/under voltage faults	0 = disable 1 = active	0
D1	All ports disable (2)	0 = normal operation 1 = all ports shut down (no ramp)	0
D0	Software RESET	0 = normal operation 1 = reset all circuits and start a POR timing cycle	0

⁽¹⁾ Register 0001, bit D5 operation inhibited after device probe.

Table 6. Port Control Write 1, Register Select = 0010 (One Per Port)

BIT	FUNCTION	WWW.100Y.COM.TW	PRESET STATE
D7	Unused	0 1001.001.001.001.001.001.001.001.001.0	0
D6	Unused	O WWW. COM TW WWW. ONY. CO.	0
D5	Discovery fault disable	0 = normal operation 1 = disable internal discovery fault limits (19 kΩ to 29.5 kΩ)	TW 0
D4	DC Disconnect disable	0 = DC Disconnect active 1 = DC Disconnect disable (for AC Disconnect)	.T. 0
D3	Function Bit 3	0000 = Disable function (power down and reset all functions) 0001 = Discovery 1 function 0010 = Discovery 2 function 0011 = port voltage sample function (V sample)	$X:I_{A}$
D2	Function Bit 2		WIIM
D1	Function Bit 1		DIVI.
D0	Function Bit 0	0100 = legacy detection function 0101 = classification function 0110 = ramp up/power function (rup pwr) 0111 = continuous sample function C Sample) 1000 = ramp power down function R _{DWN}) 1001 = ac low 1010 = ac high 1011 = port current sample function (I sample) 1100 = die temperature sample function (T sample) 1101 = spare 1110 = spare 1111 = spare	0000

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⁽²⁾ Consult factory for alternative B, semi-auto mode implementations which write to bit D1.



Table 7. Port Control Write 2, Register Select = 0011 (One Per Port)

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BIT	FUNCTION	STATE	PRESET STATE
D7	Unused	O V.	0
D6	Unused	O TIME TO THE TOTAL OF THE TANK OF THE TAN	0
D5	Unused	NY O TW WWW 100Y TW	0
D4	Port Enable ⁽¹⁾	0 = normal 1 = port disable	0
D3	A/D Start	0 = normal 1 = start A/D (self clearing)	0
D2	A/D Abort	0 = normal 1 = abort	0
D1	Unused	M. TO COM.	0
D0	Unused	M. On COMPT.	0

⁽¹⁾ Consult factory for alternative B, semi-auto mode implementations which write to bit D4.

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Table 8. Port Status Read 1, Register Select = 0100 (One Per Port)

BIT	FUNCTION	STATE WWW.COM.TW	PRESET STATE
D7	Discovery Status	0 = normal 1 = discovery fail	0
D6	Function Done Bit	0 = normal 1 = function complete (self clearing by a new function write)	0
D5	Port Class	000 = class 0 001 = class 1 010 = class 2 011 = class 3 100 = class 4	T SN
D4	Port Class		000
D3	Port Class		M CW 000
D2	Fault status (MSB)	000 = no faults	ONT.
D1 1	Fault status	001 = UV/OV fault 010 = thermal shutdown fault (TSD)	COM.TW
D0	Fault status (LSB)	011 = overload current > 50-ms fault 100 = load disconnect 101 = reserved for future 110 = reserved for future 111 = reserved for future	000

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Table 9. Port Status Read 2, Register Select = 0101 (One Per Port)

BIT	FUNCTION	STATE	PRESET STATE
D7	Unused	0 1. 1 COM.	0
D6	Unused	0 12 M	0
D5	Unused	1. O THE WAY TOOK OF THE	0
D4	Watch dog timer	0 = not active 1 = active	0
D3	A/D status	0 = not active 1 = active (conversion in process)	0
D2	Function status (MSB)	000 = disabled	
D1	Function status	001 = searching 010 = power delivery	
D0	Function status (LSB)	010 = power delivery 011 = fault 100 = test 101 = other fault 110 = undefined 111 = undefined	000

A/D Results Registers (Discovery Current, Voltage, Current and Temperature)

Table 10. Discovery Current — Lower Bits, Register Select = 0110 (One Per Port)

BIT	FUNCTION	STATE	WWW.TOOY.COM.TW	PRESET STATE
D7	A/D bit 7	A/D lower bits	WWW TOOK	0
D6	A/D bit 6	MW.IOO.COM.	MMM. TOOK. COM.	
D5	A/D bit 5	COM:1.	W. TOW. TOW.	
D4	A/D bit 4	MM. 100 Y. COM. TW	W. 100 1. COM	
D3	A/D bit 3	WWW.100Y.CO.TW	WW. 1007.Co	
D2	A/D bit 2	MAN. TO COM.	WWW. CO.	
D1	A/D bit 1	WWW.100 COM.	MW.Io. CO	
D0	A/D bit 0	MA TAN TOO Y. COM'I'M	W. 100 r. CO	

Table 11. Discovery Current — Upper Bits, Register Select = 0111 (One Per Port)

BIT	FUNCTION	STATE WWW.1007.	PRESET STATE
D7	Resistor measurement complete	0 = measurement active (bit set low at the start of Discovery 1 or Discovery 2) 1 = measurement complete (bit set high after A/D is completed during Discovery 1 or Discovery 2)	1.COM.
D6	A/D bit 14	A/D upper bits	0
D5	A/D bit 13	COM.	"COL
D4	A/D bit 12	MOX. COM'LAM MANA TOO N'THE MANA'T	ov TCO
D3	A/D bit 11	OOX.COM.TW WW. 100X.COM.TW WY.	1001.
D2	A/D bit 10	MAN TOOK CONTENT WAY	1007.0
D1	A/D bit 9	VILLOW WWW. TO COME TW WWW	. TOOX.C
D0	A/D bit 8	N.100 r. COM. I. A. M. M. Too, COM. I.	N.In

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Table 12. Voltage — Lower Bits, Register Select = 1000 (One Per Port)

BIT	FUNCTION	STATE	PRESET STATE
D7	A/D bit 7	A/D lower bits	0
D6	A/D bit 6	100X.COM.TW WW. 1100X.COM.TW	
D5	A/D bit 5	TANK COMPANY WWW. 100Y. CO. TW	
D4	A/D bit 4	MIN COM.	
D3	A/D bit 3	W.1003. COM.I.L. W.M.100, COM.3	
D2	A/D bit 2	1100X.COM.TW W. W. 100X.COW.TW	
D1	A/D bit 1	WWW. 100X.CO. TW WWW. 100X.CO.M.TW	
D0	A/D bit 0	MM.10. COM. TM	

Table 13. Voltage — Upper Bits, Register Select = 1001 (One Per Port)

BIT	FUNCTION	STATE	PRESE
To	A COM.	WWW. ON CO. THE WINN CO. TH	STATE
D7	Voltage measurement complete	0 = measurement active (bit set low when A/D begins a voltage measurement) 1 = measurement complete (bit set high after A/D has completed a voltage measurement)	0
D6	A/D bit 14	A/D upper bits	0
D5	A/D bit 13	WW. T100X.COM.TW WY. TN.100X.COM.TW	
D4	A/D bit 12	WWW. 100X.CO. TW WWW. 100X.CO. M.TW	
D3	A/D bit 11	M. M	V
D2	A/D bit 10	WWW.100 COM. I	XV.
D1	A/D bit 9	MAN TOOK OW'LL MAN TOOK OW'	
D0	A/D bit 8	TW WWW. 100X.CO. TW WWW. 100X.CO.	LIN

		STATE
07	A/D bit 7	A/D lower bits 0
D6	A/D bit 6	ONT. I COMPT AND THE ONE ON THE
D 5	A/D bit 5	OWITH WILLIAM COMITY WAY TOOK COMITY
04	A/D bit 4	TIM WW. 100X. COM.TW WW. 100X COM.T.
03	A/D bit 3	COMMEN WWW. TOOK COM TW WWW. 1001 COMME
02	A/D bit 2	COM. T. WANTED COM.
D1	A/D bit 1	COWILL MANAGER COWILL THAN TO A COM
00	A/D bit 0	DY. COMITY WILLIAM TOOK CON

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Table 15. Current — Upper Bits, Register Select = 1011 (One Per Port)

BIT	FUNCTION	STATE	PRESET STATE
D7	Current measurement complete	0 = measurement active (bit set low when A/D begins a current measurement) 1 = measurement complete (bit set high after A/D has completed a current measurement)	0
D6	A/D bit 14	A/D upper bits	0
D5	A/D bit 13	WWW. CONTRY	
D4	A/D bit 12	W.to. COM. TAN MAN. TOW. COM. TAN	
D3	A/D bit 11	M.100 Y. COM. I. T. W. TOW. TOWN.	
D2	A/D bit 10	WINTON. COMITY WINTOUT COMITY	
D1	A/D bit 9	MILLION, CONTANT WALLOW, TAN	
D0	A/D bit 8	CIMM. TO COM. TIM MANN. JON. CO. T. T.M.	

Table 16. Temperature — Lower Bits, Register Select = 1100 (One Per Port)

BIT	FUNCTION	STATE	WWW.100 F.COM.I.	PRESET STATE
D7	A/D bit 7	A/D lower bits	MW. TO CONT. TW	0
D6	A/D bit 6	M	WW.100 COM.1	
D5	A/D bit 5	WW. TOOX.COM.TW	M. 1001. CONT. LA	
D4	A/D bit 4	MAM. TOON CO.	WWW.TOOY.COM.TW	
D3	A/D bit 3	N NWW.Inc. OV.COM.	MMM.T. COM. TY	
D2	A/D bit 2	A MINITON ONLY	WW. Too COM.	
D1	A/D bit 1	WW. 100X. COM.TW	W. 100 1. COM.	
D0	A/D bit 0	TW WWW. LOOV.CO. TW	WW. 1007.00	

measurement complete 1 = measurement complete (bit set high after A/D has completed a temperature measurement) A/D bit 14 A/D bit 13 A/D bit 12 A/D bit 11 A/D bit 10 A/D bit 9	BIT	FUNCTION	TW WWW.100 STATE	PRESET STATE
5 A/D bit 13 4 A/D bit 12 3 A/D bit 11 2 A/D bit 10 1 A/D bit 9	D7		1 = measurement complete (bit set high after A/D has completed a temperature	OM.OW OM.TW
4 A/D bit 12 3 A/D bit 11 2 A/D bit 10 1 A/D bit 9	D6	A/D bit 14	A/D upper bits	CONO
3 A/D bit 11 2 A/D bit 10 1 A/D bit 9	D5	A/D bit 13	CONTIAL MATERIAL CONTIAL MANAGEMENT	COM
2 A/D bit 10 1 A/D bit 9	D4	A/D bit 12	CONTAIN MAN TOOK OWITH MAN TOOK	COMIT
1 A/D bit 9	D3	A/D bit 11	COM TW WWW. 100 Y. CO. TW WW. 100	Y.Com.
	D2	A/D bit 10	COM. WWW. TO OV. COM. TW WWW.	WY.CON
	D1	A/D bit 9	COWIT COWIT	COM
) A/D bit 8	D0	A/D bit 8	Or CONITAL MAN TOOL CONTIAL MANAGEMENT	I_{00} . $CO_{\mathbb{Z}}$

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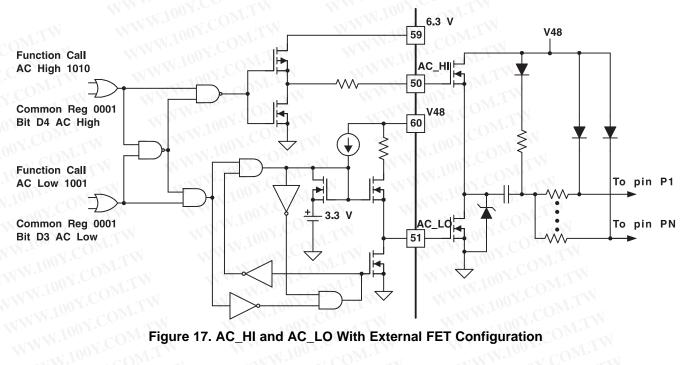
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TPS23841 AC Drive Application Schematic



WWW.100Y.COM.TW Figure 17. AC HI and AC LO With External FET Configuration WWW.100Y.COM.

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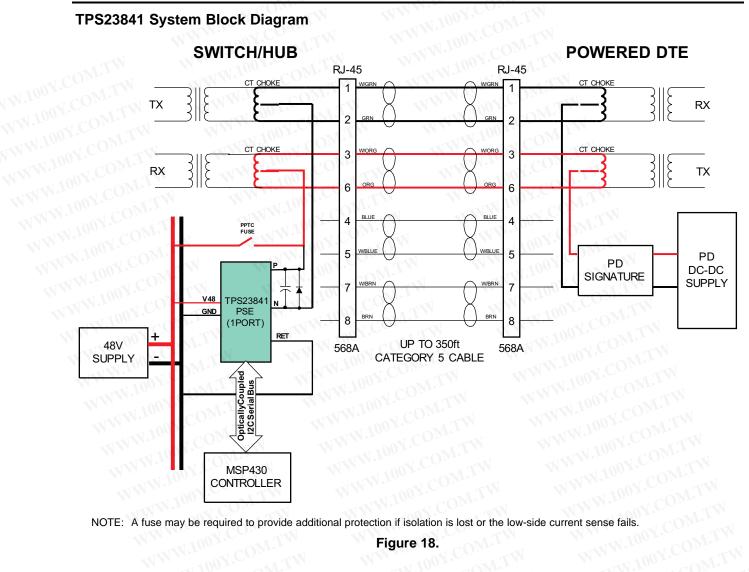
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TPS23841 System Block Diagram



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TPS23841 Basic 4-Port (PMM) Isolated Configuration with AC Disconnect

TPS23841 basic 4-port isolated configuration with AC Disconnect (PAP pinout shown).

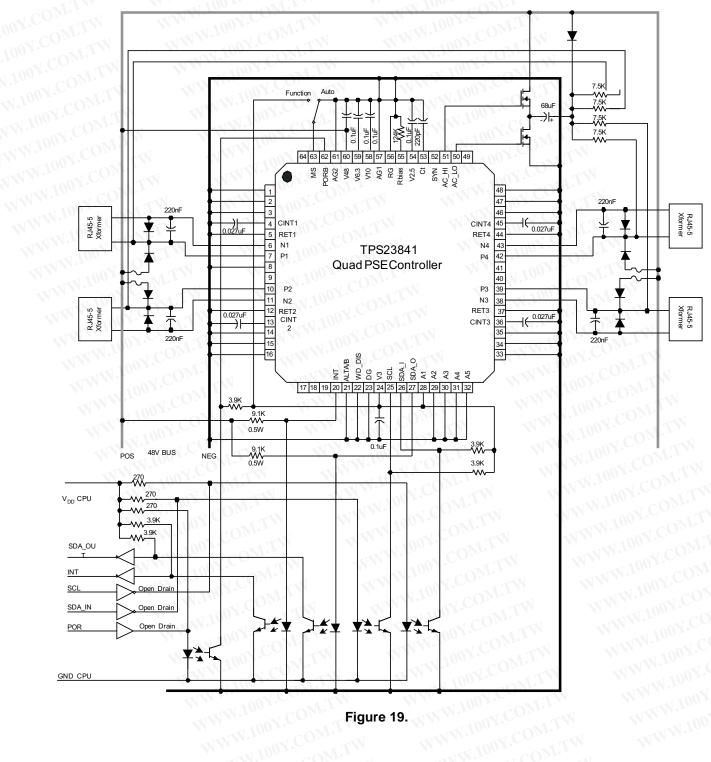


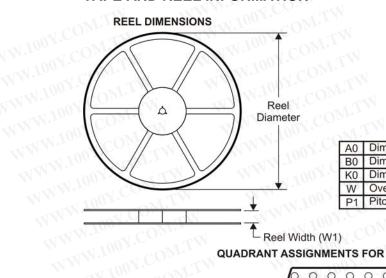
Figure 19.

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PACKAGE MATERIALS INFORMATION

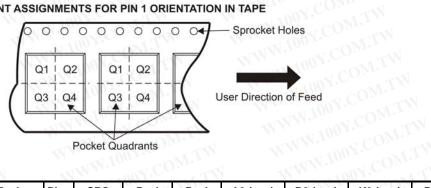
TAPE AND REEL INFORMATION



TAPE DIMENSIONS → K0 ← P1→ Ф $\Phi \Phi \Phi \Phi \Phi \Phi$ 0 0 0 B₀ → A0 ← Cavity -

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadran
PS23841PAPR	HTQFP	PAP	64	1000	330.0	24.4	13.0	13.0	1.4	16.0	24.0	Q2
PS23841PJDR	HTQFP	PJD	64	1000	330.0	24.4	13.0	13.0	1.4	16.0	24.0	Q2

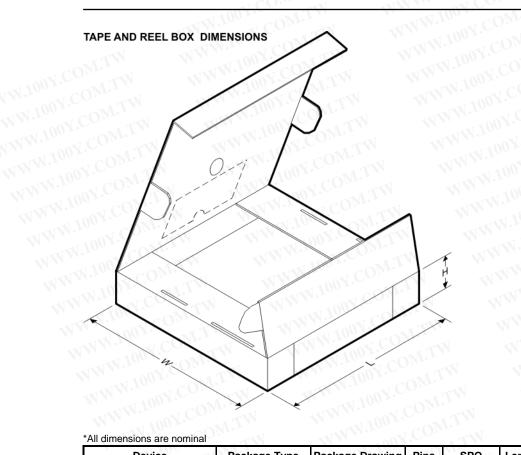
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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PS23841PAPR	HTQFP	PAP	64	1000	346.0	346.0	41.0
PS23841PJDR	HTQFP	PJD	64	1000	346.0	346.0	41.0

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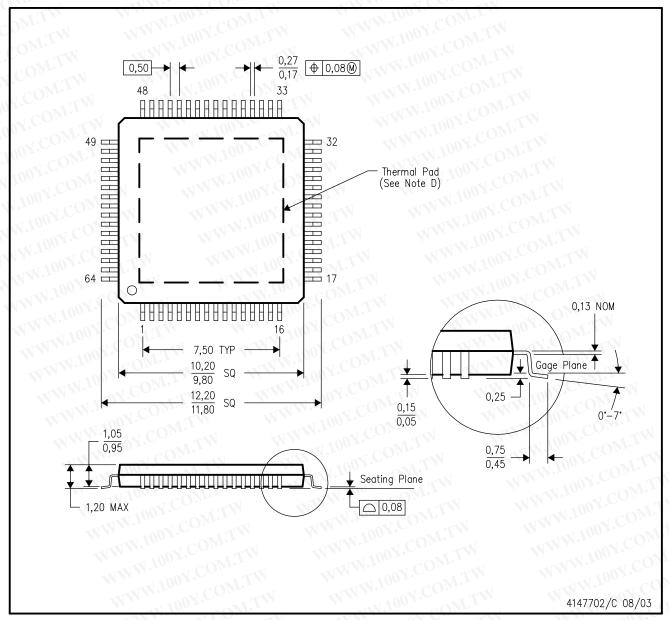
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PAP (S-PQFP-G64)

PowerPAD™ PLASTIC QUAD FLATPACK



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com www.ti.com.
- E. Falls within JEDEC MS-026

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THERMAL PAD MECHANICAL DATA

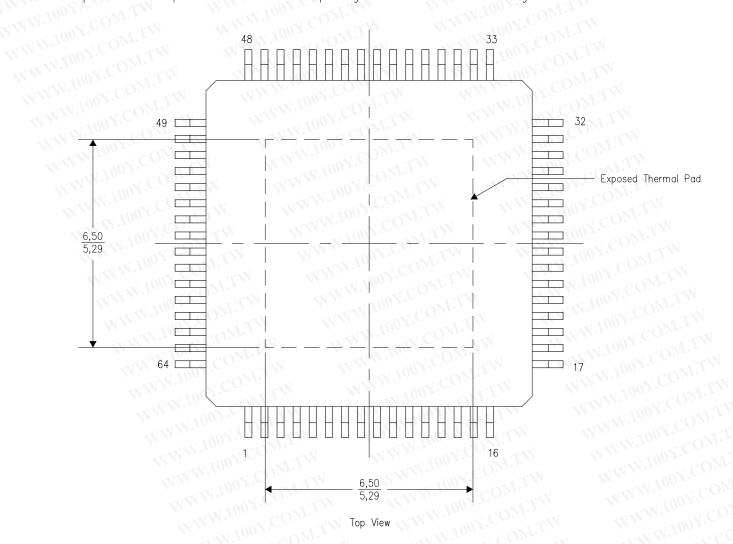
PAP (S-PQFP-G64)

THERMAL INFORMATION

This PowerPAD package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.

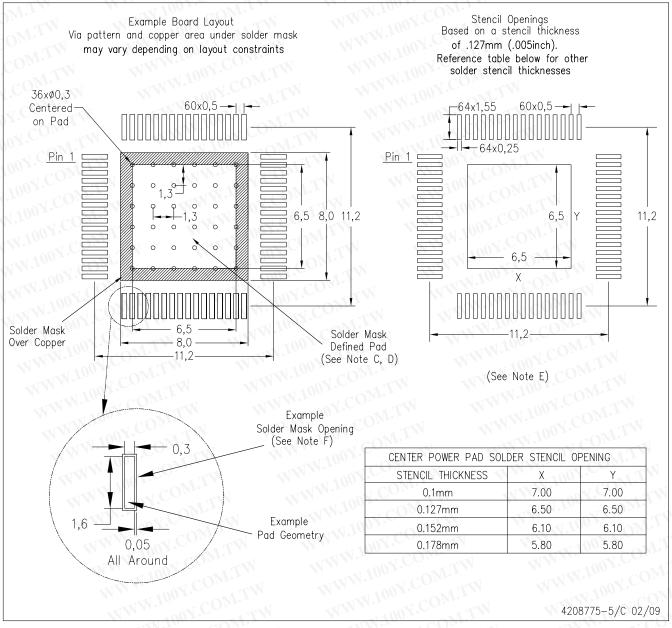


NOTE: All linear dimensions are in millimeters

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Exposed Thermal Pad Dimensions

PAP (S-PQFP-G64) PowerPAD™

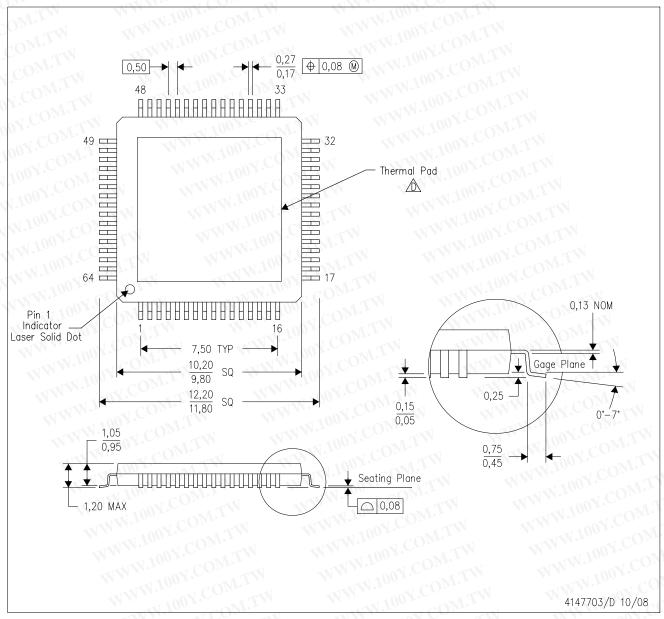


NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com http://www.ti.com. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
- F. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PowerPAD™ PLASTIC QUAD FLATPACK (DIE DOWN) PJD (S-PQFP-G64)



NOTES: All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion
- This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad WWW.100Y.COM.TV Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com http://www.ti.com>. See the product data sheet for details regarding the exposed thermal pad dimensions.
- E. Falls within JEDEC MS-026

PowerPAD is a trademark of Texas Instruments.





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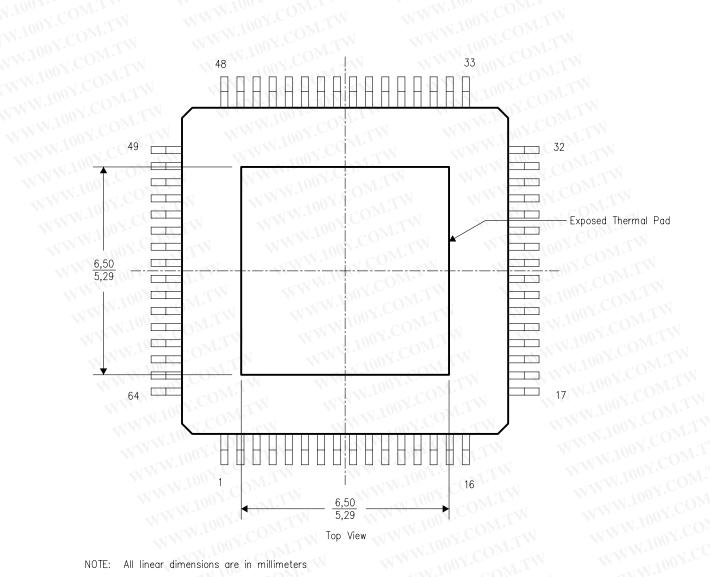
THERMAL PAD MECHANICAL DATA PJD (S-PQFP-G64)

THERMAL INFORMATION

This PowerPAD™ package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



NOTE: All linear dimensions are in millimeters

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Exposed Thermal Pad Dimensions